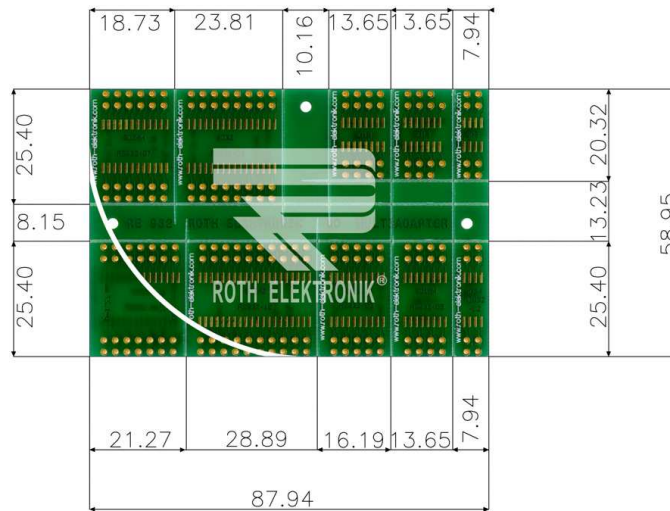


RE932

- Epoxy fibre-glass FR41.50 mm
- Double-sided 35 µm Cu
- Plated through holes (PTH)
- Surface chem. Ni/Au with solder stop mask
- Adaption circuit board for 10 different SO's
- Pitch: 1.27 mm
- Hole diameter 1.00 mm
- Prescratched rated break point for the separation of individual modules from the board
- Size 58.50 x 88.00 mm

Module-No. Pitch mil Pin Size (mm)

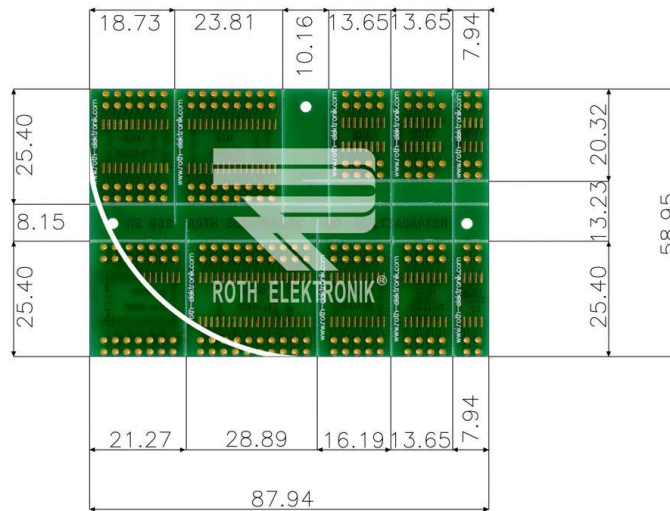
RE932-01 1.270 mm 0.50 8 3.90 (153 mil) RE932-02 1.270 mm 0.50 8-w 7.50 (295 mil) RE932-03 1.270 mm 0.50 14 3.90 (153 mil) RE932-04 1.270 mm 0.50 16 3.90 (153 mil) RE932-05 1.270 mm 0.50 16-w 7.50 (295 mil) RE932-06 1.270 mm 0.50 20-w 7.50 (295 mil) RE932-07 1.270 mm 0.50 24-w 7.50 (295 mil) RE932-08 1.270 mm 0.50 28-w 7.50 (295 mil) RE932-09 1.270 mm 0.50 32 7.50 (295 mil) RE932-10 1.270 mm 0.50 40 (SOJ) 10.16 (400 mil)



RE932

- Epoxydglashartgewebe FR4 1,50 mm
 - Zweiseitig 35 µm Cu
 - Durchkontaktiert (PTH)
 - Oberfläche chem. Ni/Au mit Lötstopplack beschichtet
 - Adaptionsplatine für 10 verschiedene SO's
 - Pitch: 1,27 mm
 - Lochdurchmesser 1,00 mm
 - Vorgesitzte Sollbruchstellen zum Trennen einzelner Module von der Platine
 - Größe 58,50 x 88,00 mm
- Modul-Nr. Pitch mil Pin Größe (mm)

RE932-01 1,270 mm 0,50 8 3,90 (153 mil) RE932-02 1,270 mm 0,50 8-w 7,50 (295 mil) RE932-03 1,270 mm 0,50 14 3,90 (153 mil) RE932-04 1,270 mm 0,50 16 3,90 (153 mil) RE932-05 1,270 mm 0,50 16-w 7,50 (295 mil) RE932-06 1,270 mm 0,50 20-w 7,50 (295 mil) RE932-07 1,270 mm 0,50 24-w 7,50 (295 mil) RE932-08 1,270 mm 0,50 28-w 7,50 (295 mil) RE932-09 1,270 mm 0,50 32 7,50 (295 mil) RE932-10 1,270 mm 0,50 40 (SOJ) 10,16 (400 mil)

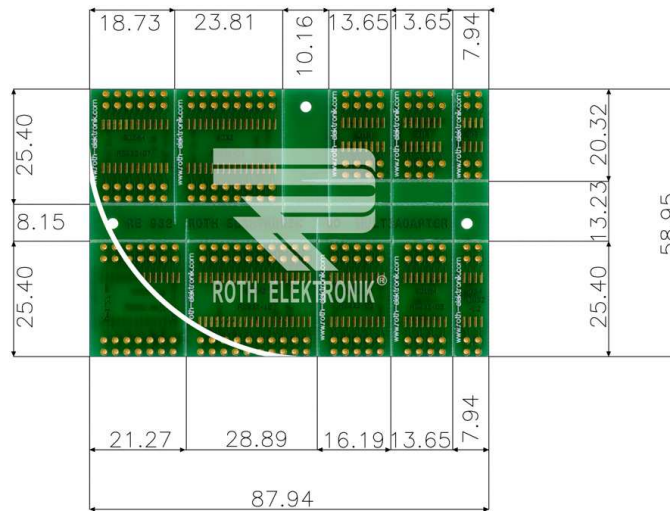


RE932

- Fibre de verre époxyde FR4 1,50 mm
- Double face 35 µm Cu
- Métallisation des trous (PTH)
- Surface avec Ni/Au chimique et un laque d'arrêt de soudure
- Platine d'adaptation pour 10 SO différents
- Pitch 1,27 mm
- Perforation 1,00 mm Ø
- Points destinés à la rupture pour séparer des modules individuels de la platine
- Dimensions: 58,50 x 88,00 mm

Module-No. Pitch mil Pin Dimensions (mm)

RE932-01 1,270 mm 0,50 8 3,90 (153 mil) RE932-02 1,270 mm 0,50 8-w 7,50 (295 mil) RE932-03 1,270 mm 0,50 14 3,90 (153 mil) RE932-04 1,270 mm 0,50 16 3,90 (153 mil) RE932-05 1,270 mm 0,50 16-w 7,50 (295 mil) RE932-06 1,270 mm 0,50 20-w 7,50 (295 mil) RE932-07 1,270 mm 0,50 24-w 7,50 (295 mil) RE932-08 1,270 mm 0,50 28-w 7,50 (295 mil) RE932-09 1,270 mm 0,50 32 7,50 (295 mil) RE932-10 1,270 mm 0,50 40 (SOJ) 10,16 (400 mil)



RE932

- Fibra de vidrio epoxídica FR4 1,50 mm
- Por dos lados 35 µm de Cu
- Agujeros con contactos metalizados (PTH)
- Superficie terminal química de Ni/Au y una máscara de inhibidora de la soldadura
- Adaptador para 10 SO diferentes
- Pitch: 1,27 mm
- Diámetro de agujeros 1,00 mm
- Puntos de ruptura controlada prerrayados para separar módulos individuales de la placa de circuito impreso
- Tamaño 58,50 x 88,00 mm

Módulo-No. Pitch mil Pin Tamaño (mm)

RE932-01 1,270 mm 0,50 8 3,90 (153 mil) RE932-02 1,270 mm 0,50 8-w 7,50 (295 mil) RE932-03 1,270 mm 0,50 14 3,90 (153 mil) RE932-04 1,270 mm 0,50 16 3,90 (153 mil) RE932-05 1,270 mm 0,50 16-w 7,50 (295 mil) RE932-06 1,270 mm 0,50 20-w 7,50 (295 mil) RE932-07 1,270 mm 0,50 24-w 7,50 (295 mil) RE932-08 1,270 mm 0,50 28-w 7,50 (295 mil) RE932-09 1,270 mm 0,50 32 7,50 (295 mil) RE932-10 1,270 mm 0,50 40(SOJ) 10,16 (400 mil)